

C3M0120065L

Silicon Carbide Power MOSFET

C3M[™] MOSFET Technology

N-Channel Enhancement Mode

Features

- 3rd generation SiC MOSFET technology
- Optimized package with separate driver source pin
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances .
- Fast intrinsic diode with low reverse recovery (Q,,) •
- Halogen free, RoHS compliant

Benefits

- Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency •

Applications

- **Datacenter Power Supplies** .
- **Telecom Power Supplies**
- **Energy Storage Systems**
- Solar (PV) inverters
- High Voltage DC/DC converters •

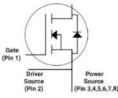
Maximum Ratings (T_c = 25 °C unless otherwise specified)

Symbol	Parameter	Value	Unit	Note	
V _{DSmax}	Drain - Source Voltage		650	V	
V_{GSmax}	Gate - Source Voltage		-8/+19	V	Note: 1
		T _C = 25°C	21		Fig. 19
ID	Continuous Drain Current, V _{GS} = 15 V	14	A	Note: 2	
I _{D(pulse)}	Pulsed Drain Current, Pulse width $t_{\rm P}$ limited by $T_{\rm jmax}$		51	А	Fig. 22
P _D	Power Dissipation, $T_c = 25^{\circ}C$, $T_J = 175^{\circ}C$	86	W	Fig. 20 Note: 2	
TJ	Junction Temperature		-40 to +175	°C	
T _c , T _{stg}	Case Temperature and Storage Temperature	-40 to +150	°C		
TL	Solder Temperature, 1.6mm (0.063") from case for 10s	260	°C		

Note (1): Recommended turn off / turn on gate voltage V $_{_{\rm GS}}$ - 4V...0V / +15V Note (2): Verified by design

Package





Orderable Part Number	Package	Marking	
C3M0120065L-TR	TOLL	C3M0120065L	

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Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	Note	
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	650			V	V_{GS} = 0 V, I _D = 100 µA		
V		1.8	2.3	3.6	V	V _{DS} = V _{GS} , I _D = 1.86 mA	Fig. 11	
V _{GS(th)} Gate Threshold Voltage			1.9		V	V _{DS} = V _{GS} , I _D = 1.86 mA, T _J = 175°C	Fig. 11	
I _{DSS}	Zero Gate Voltage Drain Current		1	50	μA	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$		
I _{GSS}	Gate-Source Leakage Current		10	250	nA	$V_{GS} = 15 V, V_{DS} = 0 V$		
Þ	Drain-Source On-State Resistance		120	157	mΩ	V _{GS} = 15 V, I _D = 6.76 A	Fig. 4,	
$R_{\text{DS(on)}}$			168			V _{GS} = 15 V, I _D = 6.76 A, T _J = 175°C	5, 6	
~	Transconductance		5		s	V _{DS} = 20 V, I _{DS} = 6.76 A	Fig. 7	
g _{fs}	Transconductance		5			V _{DS} = 20 V, I _{DS} = 6.76 A, T _J = 175°C		
C _{iss}	Input Capacitance		640			V _{GS} = 0 V, V _{DS} = 400 V		
C _{oss}	Output Capacitance		45		pF	V _{GS} – 0 V, V _{DS} – 400 V F = 1 Mhz	Fig. 17, 18	
C _{rss}	Reverse Transfer Capacitance		2.3		1	$V_{AC} = 25 \text{ mV}$		
E _{oss}	Coss Stored Energy		9		μJ	V _{DS} = 600 V, F = 1 Mhz	Fig. 16	
$C_{\text{o}(\text{er})}$	Effective Output Capacitance (Energy Related)		57		pF			
C _{o(tr)}	Effective Output Capacitance (Time Related)		79		pF	V _{GS} = 0 V, V _{DS} = 0 400V	Note: 3	
Eon	Turn-On Switching Energy (Body Diode FWD)		27			$V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, \text{ I}_{\text{D}} = 6.76\text{ A},$		
EOFF	Turn-Off Switching Energy (Body Diode FWD)		7		μJ	$R_{G(ext)}$ = 10 Ω, L= 237 µH, T _J = 25°C FWD = Internal Body Diode	Fig. 23	
t _{d(on)}	Turn-On Delay Time		5					
tr	Rise Time		10]	V_{DD} = 400 V, V_{GS} = -4 V/15 V I _D = 6.76 A, $R_{G(ext)}$ = 10 Ω,	Fig. 26	
$t_{d(off)}$	Turn-Off Delay Time		18		ns	Timing relative to V _{DS}		
t _f	Fall Time		9		1			
R _{G(int)}	Internal Gate Resistance		6		Ω	f = 1 MHz, V _{AC} = 25 mV		
Q_{gs}	Gate to Source Charge		8			V _{DS} = 400 V, V _{GS} = -4 V/15 V		
Q_{gd}	Gate to Drain Charge		7]	nC	I _D = 6.76 A	Fig. 12	
Qg	Total Gate Charge		26	1		Per IEC60747-8-4 pg 21		

Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Note (3): C_{o(er)}, a lumped capacitance that gives same stored energy as Coss while Vds is rising from 0 to 400V C_{o(tr)}, a lumped capacitance that gives same charging time as Coss while Vds is rising from 0 to 400V

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Reverse Diode Characteristics (T_c = 25°C unless otherwise specified)

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
	Diode Forward Voltage	4.5		V	$V_{_{\rm GS}}$ = -4 V, I $_{_{\rm SD}}$ = 3.4 A, T $_{_{\rm J}}$ = 25 °C	Fig. 8,
V _{SD}		4.0		V	V _{GS} = -4 V, I _{SD} = 3.4 A, T _J = 175 °C	
ls	Continuous Diode Forward Current		14	А	V _{GS} = -4 V, T _C = 25°C	
I _{S, pulse}	Diode pulse Current		51	А	$V_{_{GS}}$ = -4 V, pulse width $t_{_{P}}$ limited by $T_{_{jmax}}$	
t _{rr}	Reverse Recover time	7		ns		
Q _{rr}	Reverse Recovery Charge	93		nC	V _{cs} = -4 V, I _{sp} = 6.76 A, V _R = 400 V dif/dt = 7880 A/µs, T _J = 25 °C	
I _{rrm}	Peak Reverse Recovery Current	23		А		
t _{rr}	Reverse Recover time	8		ns		
Q _{rr}	Reverse Recovery Charge	45		nC	V _{GS} = -4 V, I _{SD} = 6.76 A, V _R = 400 V dif/dt = 2320 A/μs, T _J = 25 °C	
I _{rrm}	Peak Reverse Recovery Current	9		А		

Thermal Characteristics

Symbol	Parameter	Тур.	Unit	Test Conditions	Note
R _{0JC}	Thermal Resistance from Junction to Case	1.38	°C/W		Fig. 21



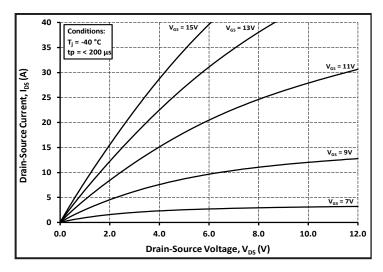
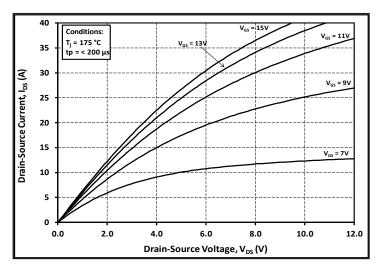
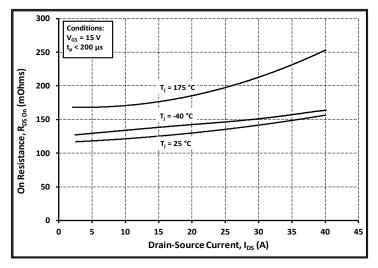
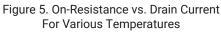


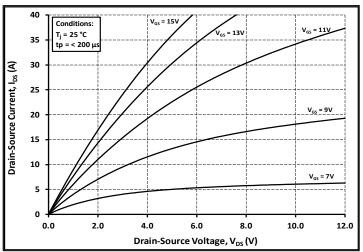
Figure 1. Output Characteristics T_J = -40 °C

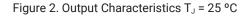


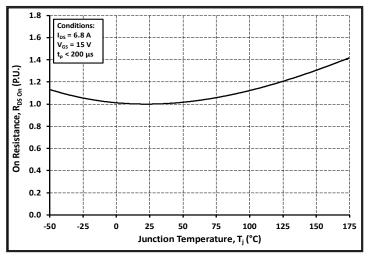














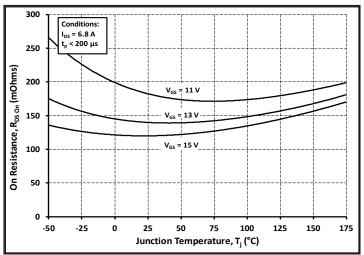


Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

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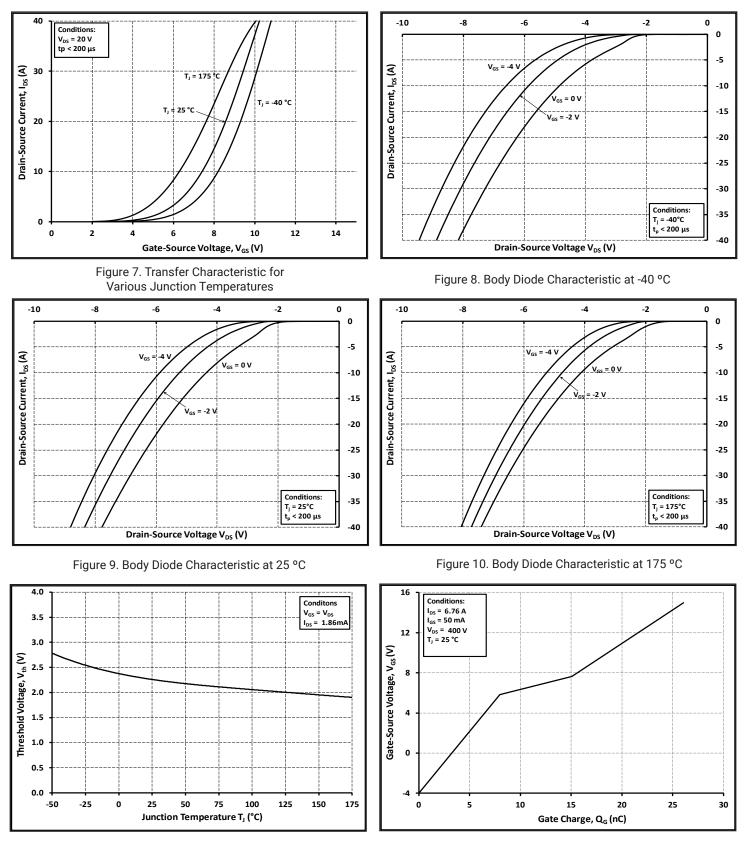


Figure 11. Threshold Voltage vs. Temperature

Figure 12. Gate Charge Characteristics

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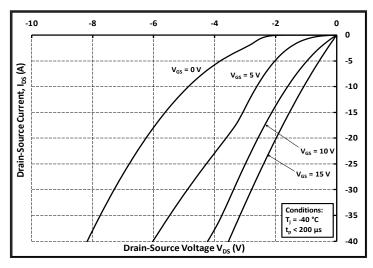


Figure 13. 3rd Quadrant Characteristic at -40 °C

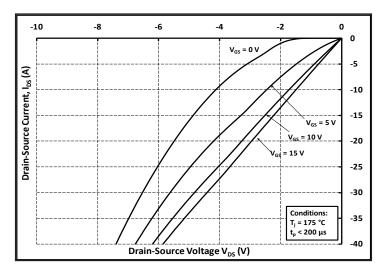
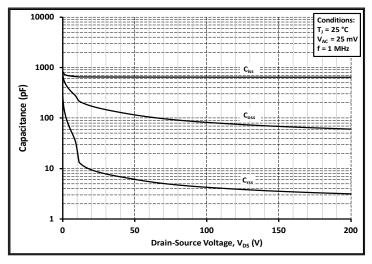
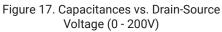


Figure 15. 3rd Quadrant Characteristic at 175 °C





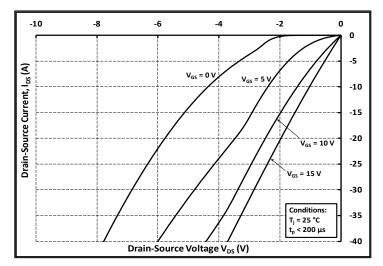


Figure 14. 3rd Quadrant Characteristic at 25 °C

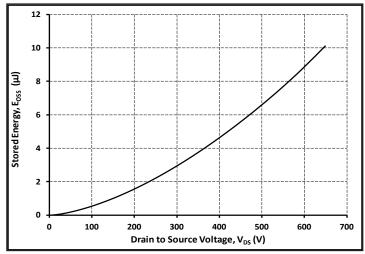


Figure 16. Output Capacitor Stored Energy

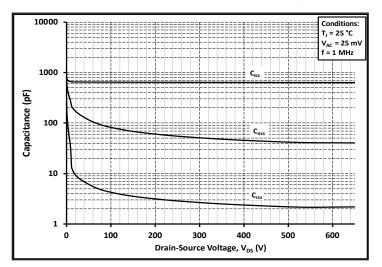
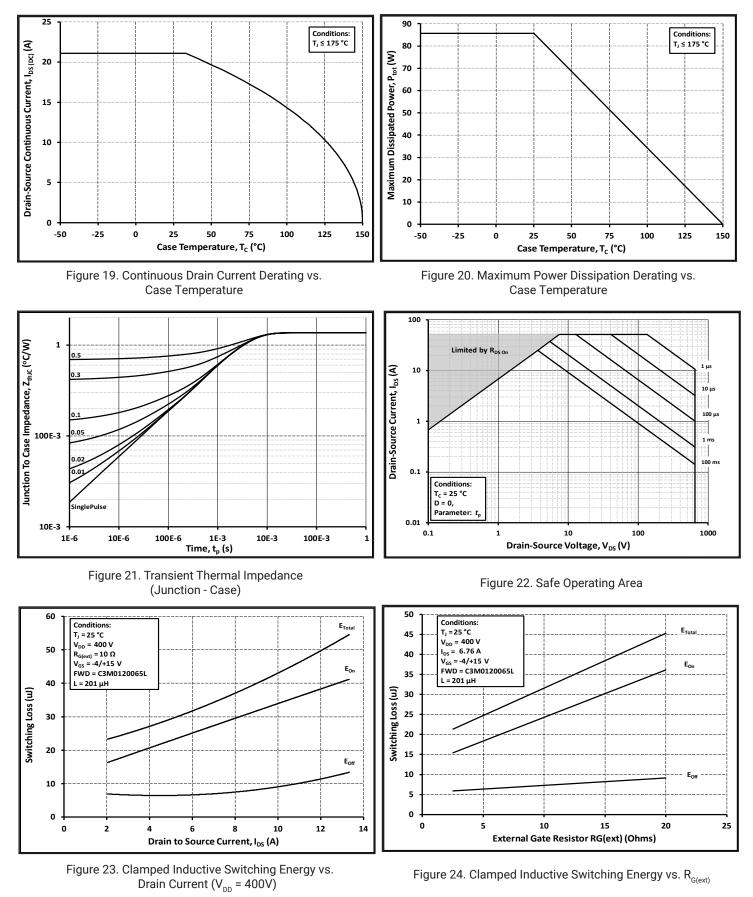


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 650V)

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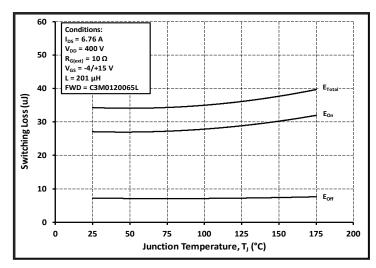


Figure 25. Clamped Inductive Switching Energy vs. Temperature

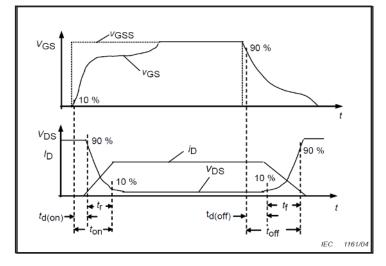


Figure 27. Switching Times Definition

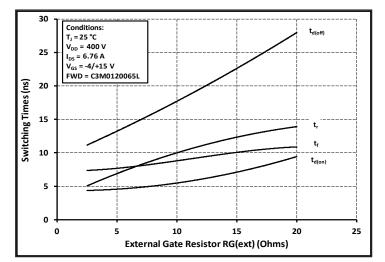


Figure 26. Switching Times vs. R_{G(ext)}

Test Circuit Schematic



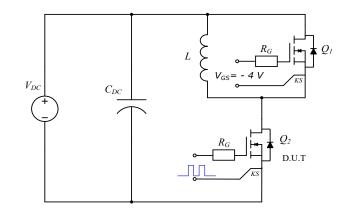
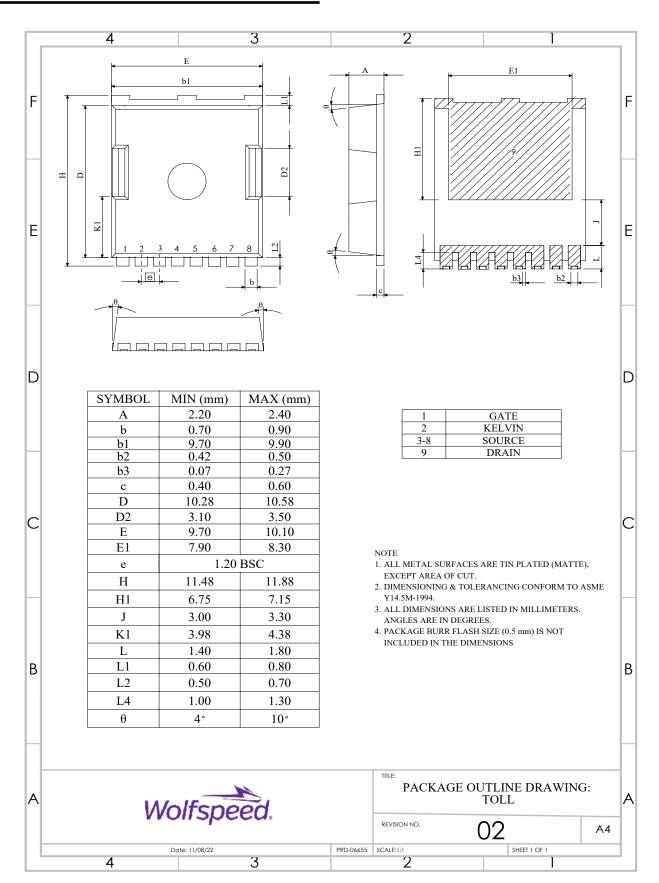


Figure 28. Clamped Inductive Switching Waveform Test Circuit

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Package Dimensions



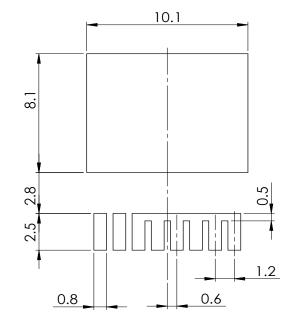


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Recommended Solder Pad Layout

(Note: All Dimensions are listed in Millimeters)



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Revision history

Document Version Date of release		Description of changes			
1.0	September-2022	Initial datasheet			
2.0	November-2022	Correction in the placement of "E1" package dimension Orderable part number information added			



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